



ZXTN19020DZ

20V NPN HIGH GAIN TRANSISTOR IN SOT89

Features

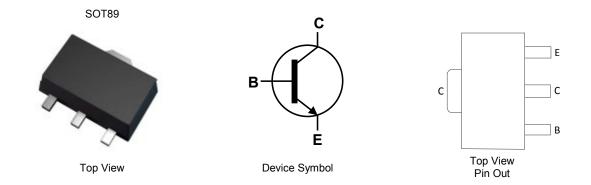
- BV_{CEO} > 20V
- I_C = 7.5A Continuous Current
- Low Saturation Voltage V_{CE(sat)} < 35mV @ 1A
- R_{sat} = 27mΩ for a Low Equivalent On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.05 grams (Approximate)

Application

- Emergency lighting circuits
- Motor driving
- Camera strobe
- Boost converter
- CCFL backlight inverters
- MOSFET gate drivers
- LED Driving



Ordering Information (Note 4)

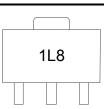
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Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
ZXTN19020DZTA	Standard	1L8	7	12	1,000

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



1L8 = Product Type Marking Code



Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	70	V
Collector-emitter voltage (forward blocking voltage)	V _{CEX}	70	V
Collector-Base Voltage	V _{CBS}	20	V
Emitter-Collector voltage (reverse blocking)	V _{ECX}	6	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	Ic	7.5	А
Peak Pulse Collector Current (single pulse)	I _{CM}	20	А
Base Current	IB	1	А

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

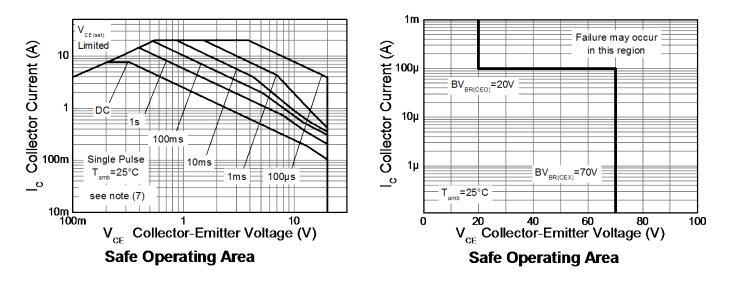
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) Linear Derating Factor	PD	1.1 1.8	W mW/°C
Power Dissipation (Note 6) Linear Derating Factor	PD	1.8 14.4	W mW/°C
Power Dissipation (Note 7) Linear Derating Factor	PD	2.4 19.2	W mW/°C
Power Dissipation (Note 8) Linear Derating Factor	PD	4.46 35.7	W mW/°C
Power Dissipation (Note 9) Linear Derating Factor	PD	27.8 222	W mW/°C
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	117	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	68	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	R _{θJA}	51	°C/W
Thermal Resistance, Junction to Ambient (Note 8)	R _{θJA}	28	°C/W
Operating and Storage Temperature Range (Note 9)	T _{J,} T _{STG}	-55 to +150	٥°

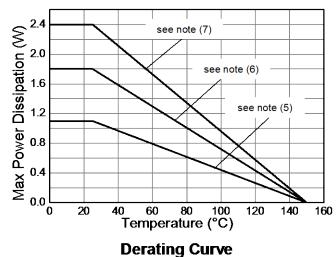
Notes: 5. For a device surface mounted on 15mm x 15mm x 0.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; device measured when operating in steady state condition.

6. Same as note (5), except the device is mounted on 25mm x 25mm x 0.6mm single sided 1oz weight copper.
7. Same as note (5), except the device is mounted on 50mm x 50mm x 0.6mm single sided 1oz weight copper.
8. Same as note (5), except the device is measured at t<5 seconds.
9. Junction to case (collector tab). Typical.



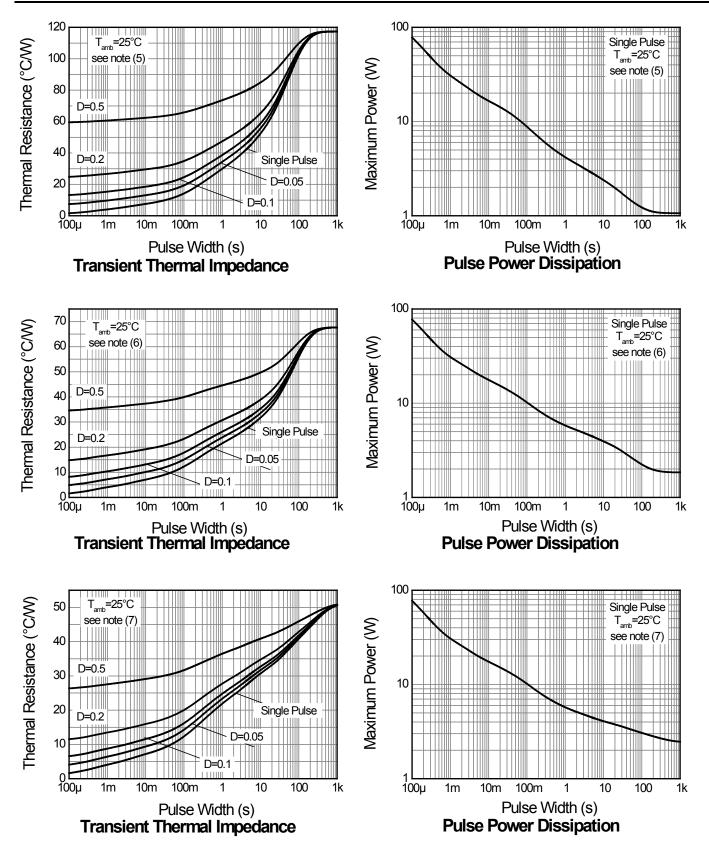
Thermal Characteristics and Derating Information







Thermal Characteristics and Derating Information





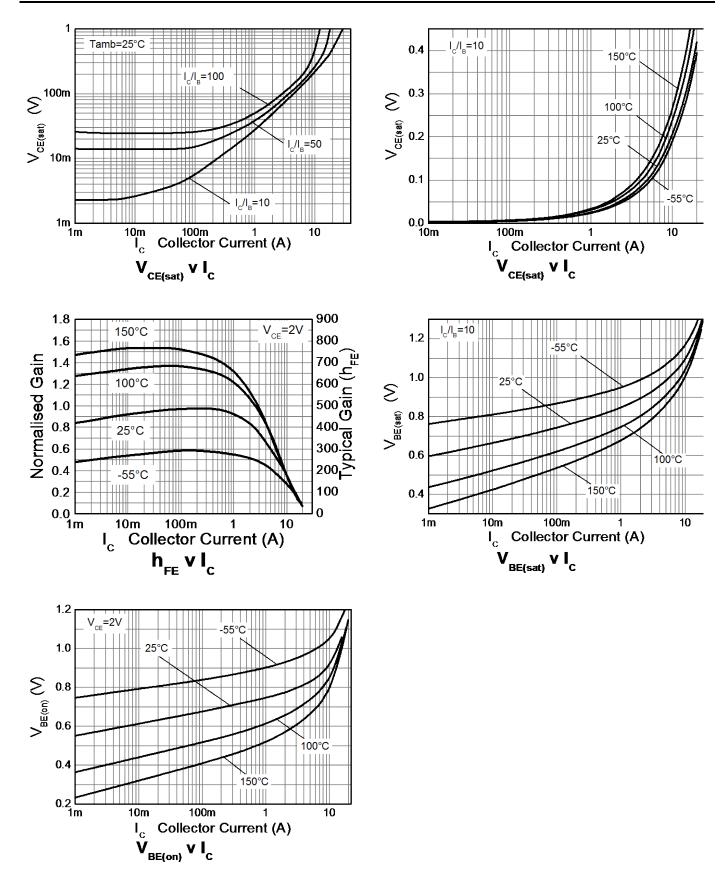
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	70	100	_	V	I _C = 100μA
Collector-Emitter Breakdown Voltage (forward blocking)	BV _{CEX}	70	100	—	V	I_C = 100µA, $R_{BE} \le 1k\Omega$ or -1V < V _{BE} < 0.25V
Collector- Emitter Breakdown Voltage (Note 10)	BV _{CEO}	20	30	—	V	I _C = 10mA
Emitter-Collector Breakdown Voltage (reverse blocking)	BV _{ECX}	6	8.4	_	V	$I_E = 100 \mu A$, $R_{BC} \le 1 k\Omega$ or 0.25V > V_{BE} > -0.25V
Emitter-Collector Breakdown Voltage (reverse blocking)	BV _{ECO}	4.5	5.7	—	V	I _E = 100μA
Emitter-Base Breakdown Voltage	BV_{EBO}	7.0	8.4	_	V	I _E = 100μA
Collector-Base Cut-Off Current	ICBO	—	1	50 0.5	nA μA	V _{CB} = 70V V _{CB} = 70V, Tamb=100°C
Collector-Emitter Cut-Off current	ICEX	_	—	100	nA	V_{CE} = 70V, $R_{BE} \le 1k\Omega$ or -1V < V_{BE} < 0.25V
Emitter-Base Cut-Off Current	I _{EBO}		1	50	nA	V _{EB} = 5.6V
Collector-Emitter Saturation Voltage (Note 10)	V _{CE(sat)}	_	26 50 75 60 83 155	32 70 100 80 105 200	mV	$\begin{split} I_{C} &= 1A, \ I_{B} = 100 \text{mA} \\ I_{C} &= 1A, \ I_{B} = 10 \text{mA} \\ I_{C} &= 2A, \ I_{B} = 20 \text{mA} \\ I_{C} &= 2A, \ I_{B} = 40 \text{mA} \\ I_{C} &= 4A, \ I_{B} = 400 \text{mA} \\ I_{C} &= 7.5A, \ I_{B} = 375 \text{mA} \end{split}$
Base-Emitter Saturation Voltage (Note 10)	V _{BE(sat)}	—	1000	1100	mV	I _C = 7.5A, I _B = 375mA
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(on)}	—	870	1000	mV	I _C = 7.5A, V _{CE} = 2V
DC Forward Gain (Note 10)	h _{FE}	300 260 150 50 —	450 390 210 75 35	900 — — —	_	$I_{C} = 100mA, V_{CE} = 2V$ $I_{C} = 2A, V_{CE} = 2V$ $I_{C} = 7.5A, V_{CE} = 2V$ $I_{C} = 15A, V_{CE} = 2V$ $I_{C} = 20A, V_{CE} = 2V$
Transitional frequency	f⊤	_	160	_	MHz	I _C = 50mA, V _{CE} = 10V f = 100MHz
Input Capacitance	Cibo		297	400	pF	V _{EB} = 0.5V, f = 1MHz
Output Capacitance	Cobo	-	32.6	40	pF	V _{CB} = 10V, f = 1MHz
Delay time	t _d		129		ns	
Rise time	tr		96			$I_{\rm C}$ = 1A, $V_{\rm CC}$ = 10V,
Storage time	ts		398			I _{B1} =-I _{B2} = 10mA
Fall time	t _f		90			

Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

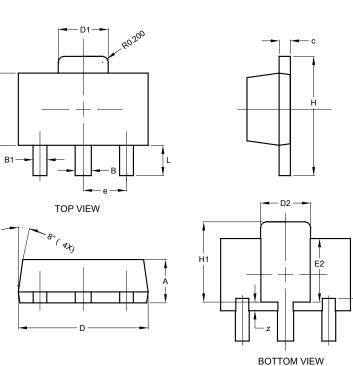




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Package Outline Dimensions

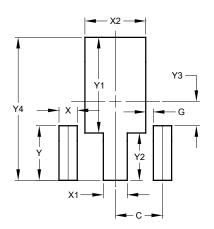
Please see http://www.diodes.com/package-outlines.html for the latest version.



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Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.50	0.62	0.56		
B1	0.42	0.54	0.48		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.62	1.83	1.733		
D2	1.61	1.81	1.71		
Е	2.40	2.60	2.50		
E2	2.05	2.35	2.20		
е	-	-	1.50		
н	3.95	4.25	4.10		
H1	2.63	2.93	2.78		
L	0.90	1.20	1.05		
L1	0.327	0.527	0.427		
z	0.20	0.40	0.30		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value		
Dimensions	(in mm)		
С	1.500		
G	0.244		
Х	0.580		
X1	0.760		
X2	1.933		
Y	1.730		
Y1	3.030		
Y2	1.500		
Y3	0.770		
Y4	4.530		

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SOT89



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